

Taiwan Semiconductor

Bi-directional ESD Protection Diode

FEATURES

- Meet IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- Designed for mounting on small surface
- Protects one Bi-directional I/O line
- Moisture sensitivity level 1
- Working Voltage : 5V, 12V, 24V
- Pb free version and RoHS compliant
- Packing code with suffix "G" means green compound (halogen-free)

MECHANICAL DATA

- Case: 1005 small outline plastic package
- Terminal : Gold plated, solder per
- MIL-STD-705, method 2026 guaranteed
- High temperature soldering guaranteed : 260°C/10s
- Weight: 6 ± 0.5 mg

APPLICATIONS

- Cell Phone Handsets and Accessories
- Notebooks, Desktops, and Servers
- Keypads, Side Keys, USB 2.0, LCD Displays
- Portable Instrumentation
- Touch Panel

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)					
PARAMETER		SYMBOL	VALUE	UNIT	
	TESDL5V0		75	w	
Peak Pulse Power (tp=8/20µs waveform)	TESDL12V	P _{PP}	25		
	TESDL24V		47		
ESD per IEC 61000-4-2 (Air)		V	± 15	- кv	
ESD per IEC 61000-4-2 (Contact)		V _{ESD}	± 8		
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

PA	RAMETER		SYMBOL	MIN	MAX	UNIT
	TESDL5V0			-	5	
Reverse Stand-Off Voltage	TESDL12V		V _{RWM}	-	12	V
	TESDL24V			-	24	
	TESDL5V0			5.1	-	
Reverse Breakdown Voltage	TESDL12V	I _R = 1 mA	V _(BR)	13	-	V
	TESDL24V			25	-	
	TESDL5V0	V _R = 5 V				
Reverse Leakage Current	TESDL12V	V _R = 12 V	I _R	-	2	μA
	TESDL24V	V _R = 24 V				
Clamping Voltage	TESDL5V0	I _{PP} = 1 A	V _c	-	9.8	V
	1ESDL5V0	I _{PP} = 5 A		-	15	v
Clamping Voltage	TESDL12V	I _{PP} = 1 A	V _c	-	25	V
	TESDLIZV	I _{PP} = 5 A		-	33	v
Clamping Voltage		I _{PP} = 1 A I _{PP} = 5 A	V _c	-	47	V
	TESDL24V		v _C	-	51	
Junction Capacitance	TESDL5V0	<u>)</u>		15		
	TESDL12V	V _R = 0 V f = 1.0 MHz	CJ		12	pF
	TESDL24V	I = I.0 MHZ			10	









1005



RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)



Fig. 3 Admissible Power Dissipation Curve











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ORDER INFORMATION (EXAMPLE)

TESDL5V0 RWG



Green compound code Packing code Part no.

PACKAGE OUTLINE DIMENSIONS



DIM.		mm) Unit ((inch)	
Divi.	Min	Max	Min	Max	
А	2.40	2.60	0.094	0.102	
В	1.10	1.30	0.043	0.051	
С	0.70	0.90	0.028	0.035	
D	0.50 (Typ.)		0.020 (Тур.)		
E	1.00 (Typ.)		0.040	(Typ.)	

SUGGEST PAD LAYOUT



DIM.	Unit (mm)	Unit (inch)
	Тур.	Тур.
А	0.70	0.028
В	1.30	0.051
С	1.30	0.051
D	2.70	0.106

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application.

MARKING

Part No.	Marking
TESDL5V0	E05
TESDL12V	E12
TESDL24V	E24



TESDL5V0/TESDL12V/TESDL24V

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APPLICATION INFROMATION

- Designed to protect one data, I/O, or power supply line
- Designed to protect sensitive electronics from damage or latch-up due to ESD
- Designed to replace multilayer varistors (MLVs) in portable applications
- Features large cross-sectional area junctions for conducting high transient currents
- Offers superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs
- The combination of small size and high ESD surge capability makes them ideal for use in portable applications

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

- Good circuit board layout is critical for the suppression of ESD induced transients
- Place the ESD Protection Diode near the input terminals or connectors to restrict transient coupling
- Minimize the path length between the ESD Protection Diode and the protected line
- Minimize all conductive loops including power and ground loops
- The ESD transient return path to ground should be kept as short as possible
- Never run critical signals near board edges
- Use ground planes whenever possible



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